

Address Mapping In Content Addressable Memory Interface with A Low Power Approach

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ABSTRACT: The addressable memory contents are pointed using address pointer. In the addressing mode, the address pointer is programmed to generate addressing location in a sequence and pass to the data bus. Here, the address pointers are used to fetch the data in a predefined sequence and the variability in address pointer would leads to high power consumption. This variability, leads to high transition and hence leads to transitional power consumption in memory interface. To minimize the power consumption, in this paper, a new reordered memory interface with correlative transition optimization is presented.

Keyword: Address mapping, content addressable memory interface, low power address realignment.

Date of Submission: 13 -12-2017

Date of acceptance: 26-12-2017

I. INTRODUCTION

With the evolution of VLSI design, the major concerns of the VLSI designer were area, performance, cost and reliability; power consideration was mostly of only secondary importance. In recent years, however, this has begun to change and, increasingly, power is being given comparable weight to area and speed considerations. Several factors have contributed to this trend. Perhaps the primary driving factor has been the remarkable success and growth of the class of personal computing devices (portable desktops, audio- and video-based multimedia products) and wireless communications systems (personal digital assistants and personal communicators) which demand high-speed computation and complex functionality with low power consumption. In these applications, average power consumption is a critical design concern. In the memory interfacing, this issues is more effective due to continuous data accessing. To optimize the power consumption in content addressable memory interface (CAM) In [1] algorithm to compile regular expression patterns into combinatorial circuits based on nondeterministic finite automaton is suggested. [2] Developed a module generator that shared common prefixes to reduce the circuit area on FPGA. [3] Presented a content-scanning module on FPGA for an internet firewall. [4] Improved area and throughput by adding pre-decoded wide parallel inputs to traditional NFA implementations. [5] Presented a pre-decoded multiple-pipeline shift-and-compare matcher which reduced routing complexity and comparator size by converting incoming characters into many bit lines. [6] proposed a sharing architecture which significantly reduces circuit areas by sharing common infix and suffix sub-patterns. From the perspectives of reconfigurability and scalability, memory architectures are attractive because memory is flexible and scalable.

The Aho–Corasick (AC) algorithm [7] is the most popular algorithm which allows for matching multiple string patterns. [8] proposed a configurable string matching accelerator based on a memory implementation of the AC FSM. [9] Proposed the bit-split algorithm partitioning a large AC state machine into small state machines to significantly reduce the memory requirements. [10] Presented an FPGA implementation of the bit-split string matching architecture. [11] Proposed to reduce the memory size by relabeling states of AC state machine. Additionally, [12] proposed to use Label Transition Table and CAM-based Lookup Table to significantly reduce the memory size. [13], [14] proposed a hash-based pattern matching co-processor where memory is used to store the list of substrings and the state transitions. [15] Proposed a pattern matching algorithm which modifies the AC algorithm to consider multiple characters at a time. Furthermore, the content addressable memories (CAM) is also widely used for string matching because it can match the entire pattern at once when the pattern is shifted past the CAM. [16] Used CAM to perform parallel search at a high speed. [17] applied the pre-decoded technique for the CAM-based pattern matching to reduce the area. Additionally, [18] presented a ternary content addressable memory (TCAM)-based multiple-pattern matching which can handle complex patterns, correlated patterns, and patterns with negation. Wherein efforts are been made to optimize power consumption in memory accessing, the addressing issue is retained. To overcome this, in this paper a new address realignment logic is suggested to overcome the transition power consumption issue.

II. ADDRESS MAPPING IN CAM

Content addressable memory addressing is an integral part of the memory interfacing operation. In the approach of memory interfacing, address are been generated as a address pointer, to generate addressing location, in the CAM operation, address pointers are decoded from the address decoder unit and allocated to the memory interfacing based on user interfacing. In the operation of address pointing, CAM, examine the contents of the entire memory to derive the pattern. Due to direct accessing mode, this memory has a faster interfacing as compared to RAM. The CAM memory interface is developed as a set of encoder, decoder and mapper logic to derive a mapping operation in CAM application. A basic interfacing unit for CAM data access is illustrated in figure 1.

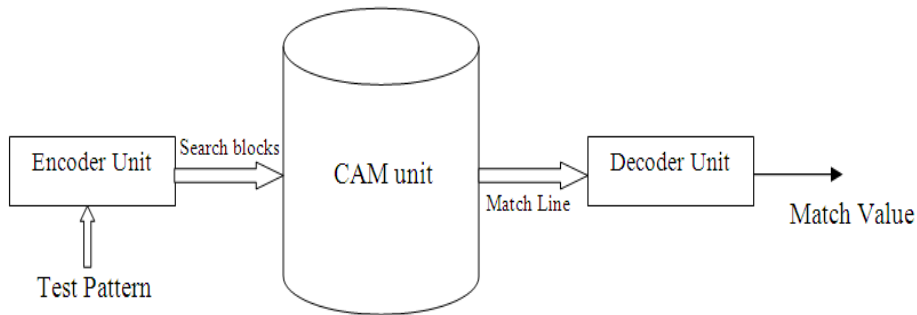


Figure 1: Interface unit for CAM data access

In the process of CAM accessing, data are exchanged in binary or ternary representation called TCAM, where a don't care 'X' is introduced for bit which are of no significance in matching. The ternary representation are hence more faster in access then binary representation. During the search operation, a search data register is initialized which defines a set of test patterns to search over the stored words. The search register are mapped to match register which intern decode to generate the result. The matching operation of this CAM operation is outlined in figure 2.

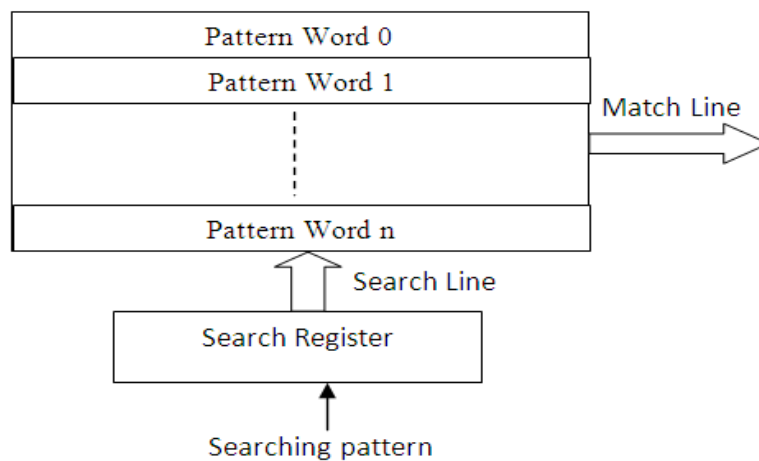


Figure 2: Operational diagram of a CAM mapping

In the operational stage of CAM accessing, the stored words are matched to the search register data to make a decision. These memory interface are predominantly been used in routers, security checking, firewalls, etc. The operation illustrates a very high interfacing transition in matching and data transfer, which leads to a high level of power dissipation in memory interfacing. It is hence, primarily required to minimize this power consumption for optimal CAM performance.

III. REORDER MEMORY INTERFACING

In the operation of CAM addressing as shown in figure 1, the CAM interface consist of a encoder and decoder unit. These encoder and decoder units are used for the generation of search patterns and matching response in CAM operation. Wherein the overhead and speed of operation is achieved via sub slotting of search

pattern, no power optimization concern is been focused. It is observed that the power dissipation is high in CAM application. To conserve power dissipation, block register [8] and counter based operation [5] were proposed. Wherein operational approach were focused in power conservation, pattern based power optimization is not focused. The power required for the storage of memory data and accessing depends on the content of this memory. As observed, each of a bit transition result in power dissipation, and the storage power required in memory storage is an additional count. In the memory interfacing, each of the transition has a volume of power dissipation given by,

$$P_d = \sum_{line} C_m V_{DD}^2 N_{tr}$$

Here, C_m is the capacitance attached to the memory unit, V_{DD} is the voltage to the line, and N_{tr} are the numbers of transition observed. As capacitance of the memory and the V_{DD} to the memory unit remain constant, it is observed that the power dissipation is proportional to the number of transition in a pattern observed. To conserve the power dissipation, hence a transition controlling is needed to minimize power consumption. In the process of transition controlling, a sequence reordering logic is proposed. The suggested approach is as illustrated in figure 3.

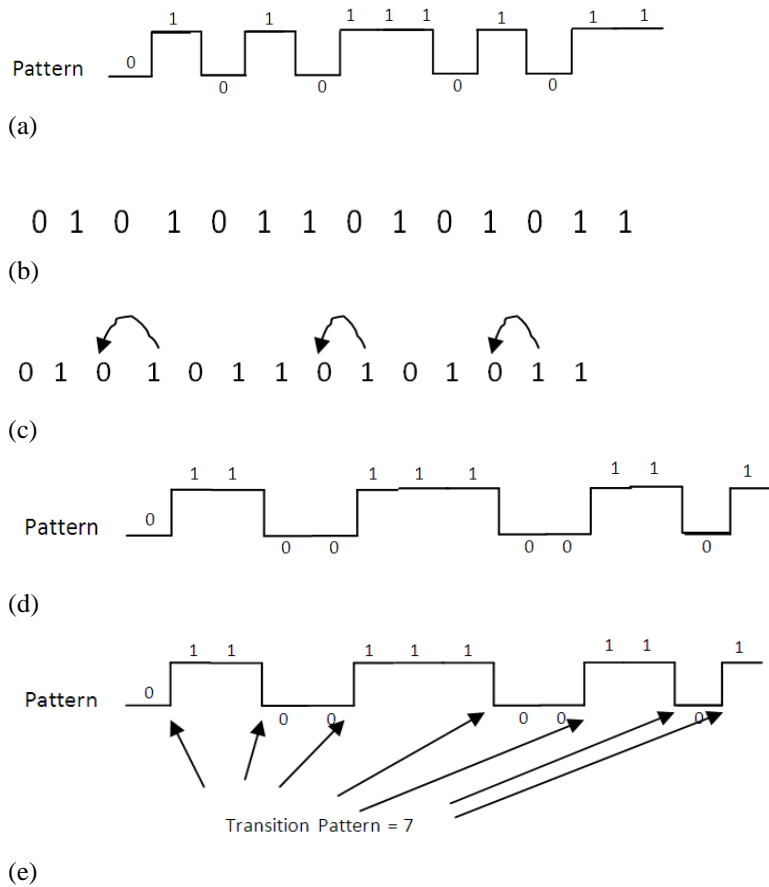


Figure 3: Reorder pattern in CAM operation (a) Original pattern, (b) Binary pattern, (c) Realignment operation, (d) Realigned Pattern, (e) Transition count

The given example, it is observed that, Actual pattern = 9, after realignment = 7.

Here, the functional operation of the encoder unit is defined with a pattern realignment logic, which performs a linear shift operation in one hop left shift to realign the patterns in a new sequence with lower transition operation. In this logic, the pattern are alien o have lower transition, as each transition result in power dissipation for level transition from high to low or low to high. Wherein a constant potential conserve this transition power dissipation. The available decoder unit performs the liner shift to get back the original pattern. The observation made is the power minimization in the transition process of interfacing and a high volume of power is conserved in the dissipation of memory storage in CAM application. The memory stores the realigned

patterns as given by the encoder unit which gives a lower transition in patterns and hence reduces the power consumption.

IV. SIMULATION RESULTS

To validate the operational performance of this proposed approach, a HDL definition for the encoder, decoder and memory unit is developed based on VHDL coding, and simulated over Aldec's Active HDL for timing operational validation. To obtain the realization logic over a targeted PLD, Xilinx FPGA device of Virtex family is considered, and the implementation details gives the realization requirement for PLD implementation. The obtained observations are illustrated in below figures.

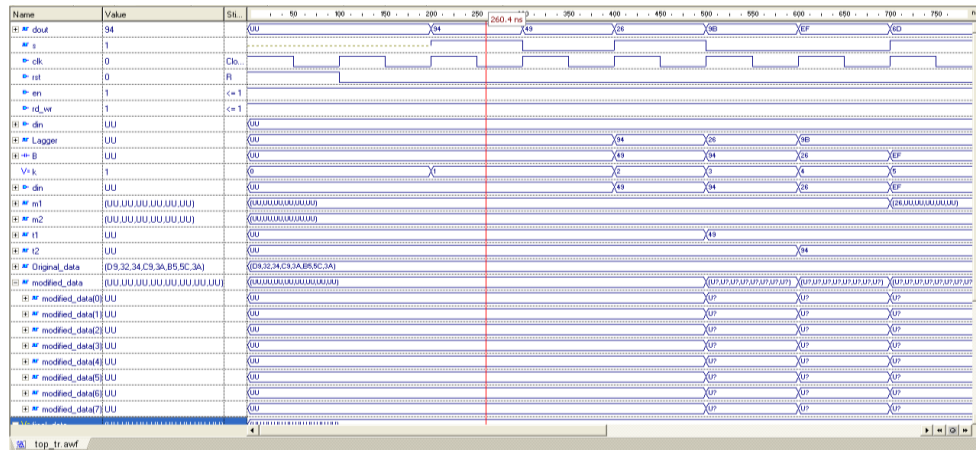


Figure 4. Simulation plot showing the observations made for the developed Sequencing algorithm

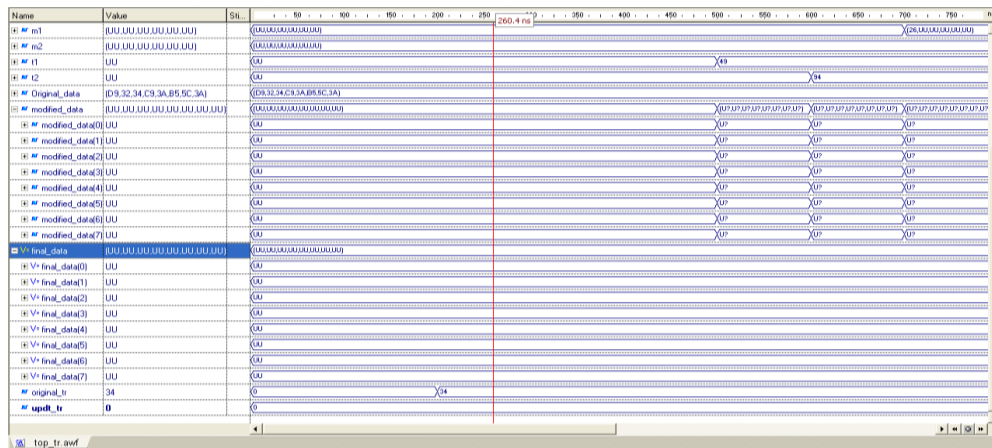


Figure 5. Figure illustrating the original data the modified data regenerated after coding

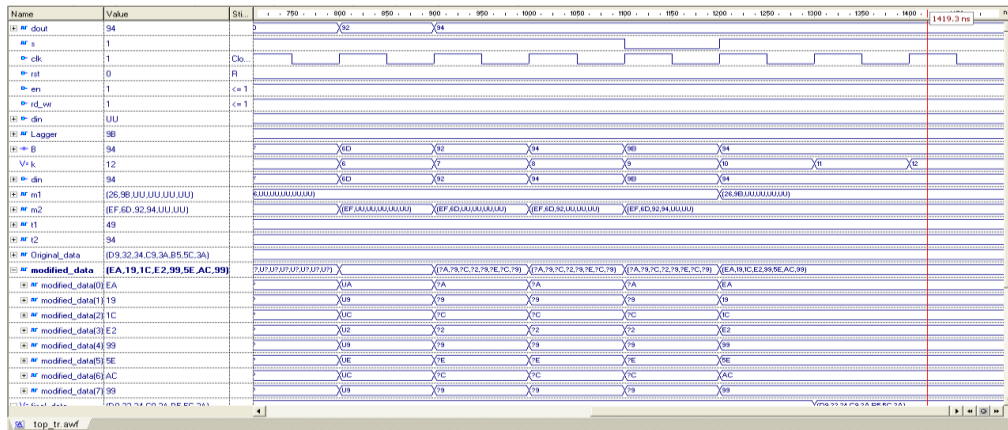


Figure 6 figure illustrating the bus , Sequencing and input data line for the designed encoder and decoder unit

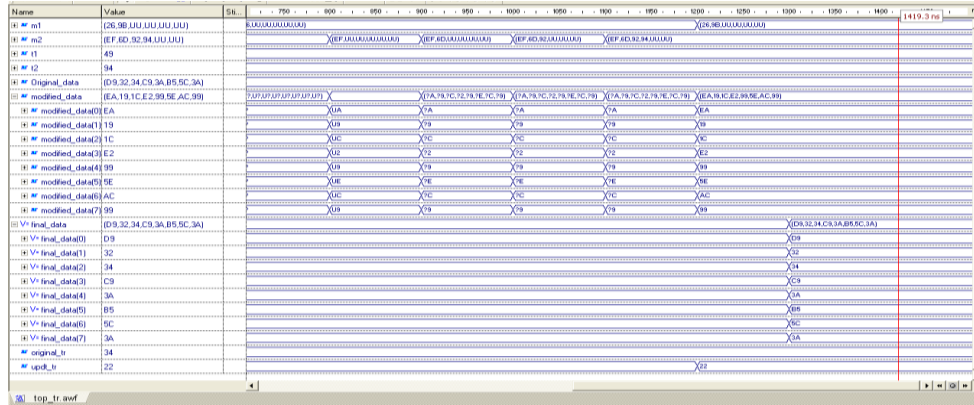


Figure 7. Illustrating the content of the memory buffered data for regeneration and the reconstructed data from it.

Implementation details on the targeted FPGA device,

Final Results

Design Statistics

```
# IOs : 34
Cell Usage :
# BELS : 542
# GND : 1
# INV : 5
# LUT1 : 124
# LUT2 : 66
# LUT3 : 15
# LUT4 : 38
# MUXCY : 147
# MUXF5 : 18
# MUXF6 : 2
# MUXF7 : 1
# VCC : 1
# XORCY : 124
# FlipFlops/Latches : 127
# FD : 15
# FDE : 80
# FDR : 32
# Clock Buffers : 1
# BUFGP : 1
# IO Buffers : 33
# IBUF : 17
# OBUF : 16
```

TIMING REPORT

Clock Information:

Speed Grade: -6

Minimum period: 7.693ns (Maximum Frequency: 129.984MHz)

Minimum input arrival time before clock: 2.950ns

Maximum output required time after clock: 3.615ns

Maximum combinational path delay: No path found

TRB Partition Summary				
No partition information was found.				
Device Utilization Summary				
Logic Utilization	Used	Available	Utilization	Note(s)
Number of Slice Flip Flops	113	88,192	1%	
Number of 4 input LUTs	123	88,192	1%	
Logic Distribution				
Number of occupied Slices	134	44,096	1%	
Number of Slices containing only related logic	134	134	100%	
Number of Slices containing unrelated logic	0	134	0%	
Total Number of 4 input LUTs	261	88,192	1%	
Number used as logic	123			
Number used as a route-thru	138			
Number of bonded IOBs	34	1,164	2%	
IOB Flip Flops	14			
Number of PPC405s	0	2	0%	
Number of GCLKs	1	16	6%	
Number of GTs	0	20	0%	
Number of GT10s	0	0	0%	
Total equivalent gate count for design	2,633			
Additional JTAG gate count for IOBs	1,632			

Figure 8. Summarized synthesis report for the developed estimation system

 Release 9.1i - XPower Software Version: J.30
 Copyright (c) 1995-2007 Xilinx, Inc. All rights reserved.
 Design: C:\Xilinx91i\Coding\transition.ncd
 Preferences: transition.pcf
 Part: 2vpx70ff1704-6
 Data version: PREVIEW, v1.0, 05-28-03

Power summary: I(mA) P(mW)

 Total estimated power consumption: 112

Vccint 1.50V: 85 112
 Vccaux 2.50V: 20 50
 Vcco25 2.50V: 2 4

Clocks: 0 0
 Inputs: 0 0
 Logic: 0 0
 Outputs:
 Vcco25 0 0
 Signals: 0 0

Quiescent Vccint 1.50V: 85 112
 Quiescent Vccaux 2.50V: 20 50
 Quiescent Vcco25 2.50V: 2 4

Thermal summary:

 Estimated junction temperature: 25C
 Ambient temp: 25C
 Case temp: 25C
 Theta J-A: 0C/W

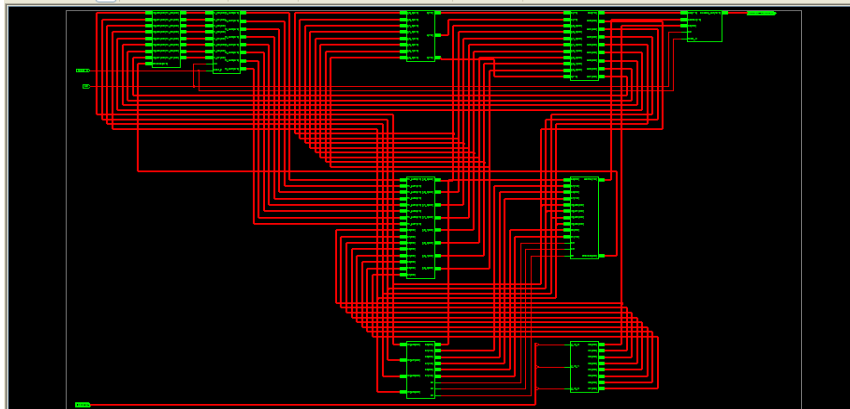


Figure 9. RTL view of the implemented system using Xilinx synthesizer.

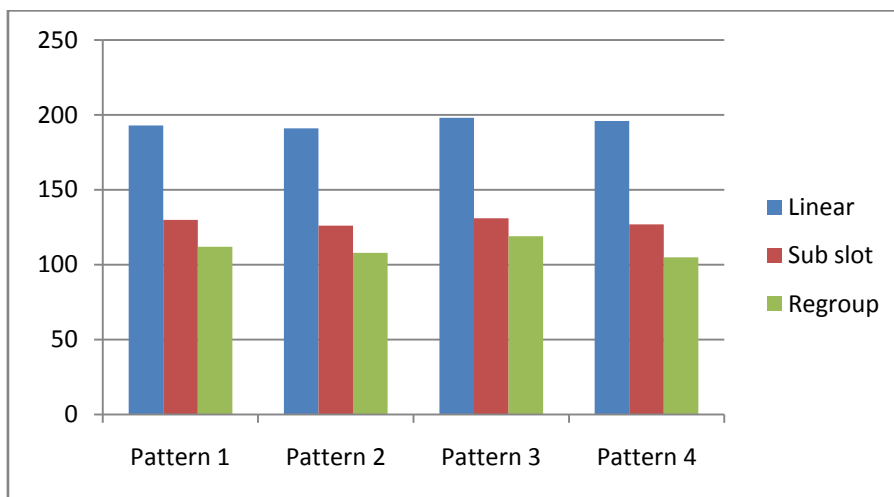


Figure 10: Comparative analysis of power dissipation in CAM operation

CAM interfacing	Processing Iteration	Power (mW)
Linear mapping [9]	1310	197
Sub slot mapping [4]	976	130
Transition control mapping	1040	112

Table 1: Result comparison of power dissipation in CAM operation

The observation of a CAM operation for a memory interfacing of 2KB, 16 bit memory interface tested over 4 different patterns is presented in table 1. The power utilization in the proposed transition controlling is observed to be 18mW lower than the conventional linear and sub slot approach.

V. Conclusion

This paper a new approach to addressing of content Addressable memory interfacing is developed. The proposes approach gives a significance of address pointer records and realignment of address register to minimize the correlative transition to optimize power consumption. In the proposed approach, the minimal cross correlation address logic are grouped to formulate the address logic. The power dissipation and the operational iteration are observed to be optimized, where an minimal increment in processing iteration is observed due to extra encoding and decoding operation, the power consumption is comparatively minimized due to reduced transition operation. This leads to a low power operation in CAM interfacing.

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K. Suresh Kumar. “Address Mapping In Content Addressable Memory Interface With A Low Power Approach.” *International Journal Of Engineering Research And Development*, vol. 13, no. 12, 2017, pp. 31–38.